

# Encapsulation Resins Market - Global Industry Size, Share, Trends, Opportunity, and Forecast, 2018-2028 Segmented By Resin Type (Epoxy Resins, Polyurethane Resins, Silicone Resins, Others), By End User (Automotive, Consumer Electronics, Industrial, Telecommunication, Others), By Region and Competition

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## Abstracts

Global Encapsulation Resins Market was valued at USD4.17 billion in 2022 and is anticipated to project robust growth in the forecast period with a CAGR of 3.65% through 2028. Encapsulation resins, also known as potting resins or casting resins, are specially formulated materials widely utilized in various industries to provide protection and insulation to electronic components or devices. These resins are specifically designed to create a protective layer that shields the packaged components from moisture, dust, chemicals, and physical damage. With their excellent electrical insulation properties, encapsulation resins effectively prevent short circuits and electric shocks.

Typically, encapsulating resins are thermosetting polymers such as epoxy or polyurethane. These polymers undergo a curing process to form a strong and durable protective layer. This protective coating significantly enhances the lifespan and reliability of the packaged components, making them ideal for demanding applications and environments, including automotive, aerospace, electronics, and telecommunications.

In addition to their widespread use in various industries, encapsulating resins also find extensive application in sensor devices. These resins play a crucial role in safeguarding sensitive electronic components and sensing devices. One of the key advantages they

offer is environmental protection. Sensors often operate in harsh conditions, experiencing temperature fluctuations, humidity, chemical exposure, and mechanical stress. The encapsulation resin acts as a barrier, shielding these delicate parts from external factors.

Furthermore, many sensors rely on electrical signals for their operation. Encapsulation resins with high dielectric strength serve as excellent electrical insulators, effectively preventing short circuits and minimizing signal interference. Apart from electrical protection, encapsulation resins are primarily employed to shield electronic products and equipment from physical shocks, corrosive gases, chemicals, heat, and dust, among other potential hazards. These resins can be used for packaging individual components or entire units, ensuring comprehensive protection in demanding environments.

By utilizing encapsulating resins, industries can ensure the longevity, reliability, and performance of their electronic components and devices, even in challenging operating conditions.

## Key Market Drivers

### Growing Demand of Encapsulation Resins in Automotive Industry

Encapsulation resins play a crucial role in the automotive industry's electronic systems by providing a protective layer for sensitive components. These resins are specifically designed to encapsulate and safeguard electronic parts, including sensors, microcontrollers, and power modules, against harsh operating conditions. By offering excellent thermal conductivity, electrical insulation, and environmental resistance, encapsulation resins ensure the optimal performance and longevity of these components, making them highly desirable for use in vehicles.

The demand for encapsulation resins has been further amplified by the growing prevalence of electric vehicles (EVs) and hybrid electric vehicles (HEVs). As these vehicles require high-performance electronic systems, such as battery management systems and power control units, the need for reliable encapsulation resins becomes even more critical. These resins not only protect the sensitive electronics from external factors but also contribute to the overall functionality and safety of the vehicle.

The automotive industry is currently experiencing a rapid transformation driven by technological advancements, such as autonomous driving, connected cars, and

electrification. These innovations necessitate the integration of sophisticated electronics into vehicles, which in turn require robust protection from various environmental factors like vibration, moisture, dust, and temperature fluctuations. Encapsulation resins serve as a vital solution to meet these challenges, ensuring the reliability and durability of electronic components in the modern automotive landscape.

Furthermore, the advent of autonomous vehicles has led to a substantial increase in the number of sensors and electronic components per vehicle. Each of these components necessitates proper encapsulation for long-term protection and functionality, further driving up the demand for encapsulation resins in the automotive industry.

In addition to technological advancements, government regulations worldwide are also pushing automakers towards producing cleaner and more efficient vehicles. The shift towards electrification has resulted in a surge in the production of EVs and HEVs, which inherently require a higher number of electronic components compared to conventional vehicles. To ensure the longevity and reliability of these components, encapsulation resins are indispensable, thus fueling the demand for their usage in the automotive sector.

In summary, encapsulation resins play a fundamental role in protecting and enhancing the performance of electronic components in the automotive industry. With their ability to withstand harsh conditions, provide thermal conductivity, and ensure electrical insulation, encapsulation resins are indispensable in the face of technological advancements, the rise of EVs and HEVs, and the increasing focus on cleaner and more efficient vehicles.

### Growing Demand of Encapsulation Resins in Electronic Industry

Encapsulation resins play a crucial role in the electronics industry, providing essential protection for delicate electronic components against various environmental factors like moisture, dust, and temperature fluctuations. These resins not only safeguard the components but also offer excellent electrical insulation and thermal conductivity, ensuring optimal performance of electronic devices.

In a wide range of electronic applications, including printed circuit boards, semiconductors, sensors, and transistors, encapsulation resins serve as a shield, preventing physical damage and chemical corrosion. This extends the lifespan and enhances the reliability of these components.

The ever-evolving landscape of the electronics industry, driven by rapid technological advancements, has led to an exponential surge in the demand for encapsulation resins. With the rise of the Internet of Things (IoT), artificial intelligence (AI), and 5G technology, electronic devices have become increasingly complex and miniaturized. The intricate circuits and components in these devices require robust protection, precisely what encapsulation resins offer.

Furthermore, the growing trend towards smart homes and cities, where interconnected electronic devices and sensors are powering the way we live, has further intensified the need for reliable encapsulation solutions. This surge in demand for encapsulation resins is driven by the desire to ensure the longevity and performance of these devices in a connected ecosystem.

The booming consumer electronics sector is another significant driver of the encapsulation resins market. The proliferation of smartphones, tablets, wearable devices, and home entertainment systems has significantly increased the demand for encapsulation resins. These devices are often exposed to harsh environments and heavy usage, which necessitates high-quality encapsulation to ensure their durability and optimal performance.

## Key Market Challenges

### Volatility in Price of Raw Materials

Encapsulation resins, which are commonly used in various industries, are primarily composed of raw materials such as epoxy resins, silicones, and polyurethanes. These raw materials serve as the building blocks for the production of encapsulation resins, and their prices can exhibit significant volatility due to various factors.

One of the key drivers of price volatility in encapsulation resin raw materials is the supply-demand dynamics. Fluctuations in the availability of these materials can result from a range of factors, including changes in production capacities, market demand, and inventory levels. When demand outpaces supply, prices can rise, while oversupply can lead to price decreases.

Geopolitical events also play a crucial role in raw material price volatility. Disruptions in the global supply chain caused by natural disasters, political instability, or trade disputes can have a direct impact on the availability and cost of raw materials. For example, conflicts in oil-producing regions can cause crude oil prices to spike, affecting the cost

of petroleum-based raw materials like polyurethanes.

Moreover, changes in energy prices can significantly influence the cost of raw materials used in encapsulation resins. Fluctuations in energy markets, driven by factors such as production levels, renewable energy adoption, and geopolitical tensions, can directly impact the prices of raw materials like epoxy resins and silicones.

In addition to supply-demand dynamics and geopolitical events, regulatory factors also contribute to the price volatility of encapsulation resin raw materials. Environmental regulations, for instance, can impose restrictions on the production and disposal of certain raw materials, leading to additional costs that are eventually passed on to customers.

Currency fluctuations further add to the complexity of raw material price volatility. As raw materials are often traded in global markets, changes in exchange rates can affect the purchasing power of manufacturers and impact the cost of importing or exporting raw materials.

## Key Market Trends

### Rising Advancements in Formulation

Encapsulation resins are widely used in various industries such as electronics, automotive, and telecommunications, primarily because of their exceptional ability to protect delicate components from environmental stressors. As these sectors continue to evolve and advance, the demand for more advanced encapsulation resins is also on the rise.

In recent years, there has been a noticeable shift towards the development of new formulations that further enhance the properties of encapsulation resins. These advancements focus on improving crucial aspects such as thermal conductivity, electrical insulation, and environmental resistance, all of which play a vital role in ensuring the optimal performance of encapsulated components.

The semiconductor industry, in particular, is experiencing significant benefits from these formulation advancements. With the increasing complexity of semiconductor devices, the need for high-performance encapsulation resins has become paramount. Enhanced formulations offer improved protection for semiconductors, guaranteeing their longevity and reliability.

Furthermore, the chip encapsulation resin market is poised for substantial growth, driven by the constantly rising demand for electronic devices. Advanced formulations provide even better protection for electronic components, safeguarding them against physical damage and chemical corrosion.

Another noteworthy trend in the encapsulation resins market is the increasing demand for sustainable and environmentally friendly resins. Manufacturers are placing greater emphasis on developing formulations that minimize environmental impact without compromising performance. This trend aligns with the growing global consciousness about environmental sustainability and the push for greener manufacturing practices.

## Segmental Insights

### Resin Type Insights

Based on the category of resin type, the epoxy resins segment emerged as the dominant player in the global market for encapsulation resins in 2022. Epoxy resins have been widely used in a range of applications for many years, thanks to their exceptional properties. These resins exhibit low shrinkage upon curing, making them highly desirable. Additionally, they possess toughness, superior chemical resistance, and hardness, making them suitable for various industrial uses.

One of the key advantages of epoxy resins is their ease of application. They offer a low coefficient of thermal expansion, which ensures dimensional stability even under extreme temperature variations. Furthermore, they provide excellent protection against harsh chemicals and humidity, making them ideal for demanding environments.

When used as an encapsulation material in electronic applications, epoxy resin demonstrates excellent dielectric properties, thermal conductivity, mechanical strength, and electrical insulation strength. These properties contribute to the reliable and efficient performance of electronic devices.

Moreover, epoxy resin is considered a cost-effective solution for encapsulation, offering superior adhesion to a wide range of substrates. This versatility makes it a preferred choice in various industries, including electronics, automotive, aerospace, and more.

## End User Insights



The consumer electronics segment is projected to experience rapid growth during the forecast period. Epoxy, polyurethane, and silicone resins are widely used in encapsulation and potting in a range of electrical and electronics applications. These versatile resins play a crucial role in protecting electrical components and devices from harsh environmental conditions, ensuring their longevity and reliability. Moreover, they offer a robust defense against security threats such as tampering, safeguarding sensitive electronic components.

Encapsulation can be applied to various electrical applications, including integrated circuits (ICs), capacitors, and diodes. The process provides numerous benefits, including low shrinkage upon curing, flexibility, and a strain relief system for wire leads, effectively minimizing the risk of wire breakage. These advantages contribute to the overall durability and performance of the encapsulated components.

With the ever-changing and evolving electrical and electronics industry, driven by the demand for emerging e-mobility and the development of small yet powerful devices, the need for innovative resins continues to rise. The growing market for electrical and electronics applications creates a significant demand for advanced encapsulation resins that can meet the evolving requirements of the industry.

## Regional Insights

Asia Pacific emerged as the dominant player in the Global Encapsulation Resins Market in 2022, holding the largest market share in terms of value. The impressive growth of encapsulation resins in the Asia Pacific region can be primarily attributed to the surge in demand for these resins across a wide range of electronics applications. These applications include components, devices, printed circuit boards, photonic integrated circuits, sensor assemblies, transformers, cables, and many others. The region boasts a notable presence of electrical and electronics players, which, combined with the remarkable growth of the industry over the years, further fuels the market expansion.

Moreover, the increasing adoption of encapsulation resins in various electronics devices, as well as their utilization in the automotive, aerospace, and building and construction sectors, significantly contributes to the rising demand for encapsulation resins in the Asia Pacific region. This trend is expected to continue in the coming years, driving further growth in the market.

## Key Market Players

Henkel AG

Hitachi Chemical Industries Co., Ltd.

Huntsman International LLC

H.B. Fuller Company

Acc Silicones Ltd

BASF SE

The Dow Chemical Company

Fuji Chemical Industry Co Ltd

Shin-Etsu Chemical Co Ltd.

Robnor ResinLab Ltd

Report Scope:

In this report, the Global Encapsulation Resins Market has been segmented into the following categories, in addition to the industry trends which have also been detailed below:

Global Encapsulation Resins Market, By Resin Type:

Epoxy Resins

Polyurethane Resins

Silicone Resins

Others

Global Encapsulation Resins Market, By End User:

Automotive



Consumer Electronics

Industrial

Telecommunication

Others

Global Encapsulation Resins Market, By Region:

North America

United States

Canada

Mexico

Europe

France

United Kingdom

Italy

Germany

Spain

Asia-Pacific

China

India

Japan

Australia

South Korea

South America

Brazil

Argentina

Colombia

Middle East & Africa

South Africa

Saudi Arabia

UAE

## Competitive Landscape

Company Profiles: Detailed analysis of the major companies present in the Global Encapsulation Resins Market.

## Available Customizations:

Global Encapsulation Resins Market report with the given market data, Tech Sci Research offers customizations according to a company's specific needs. The following customization options are available for the report:

## Company Information

Detailed analysis and profiling of additional market players (up to five).

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